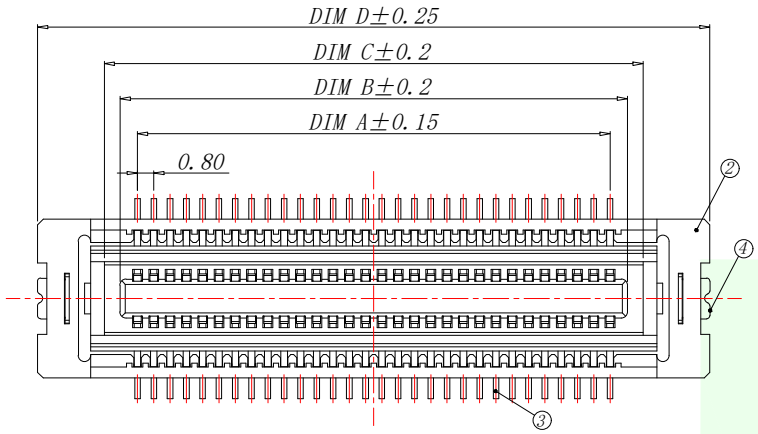
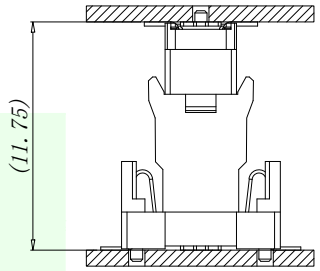


技术指标:

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象.
2. 温度范围:-40° C～85° C.
3. 额定电压:50V, AC.
4. 接触电阻:≤0.1Ω.
5. 绝缘电阻:≥500MΩ

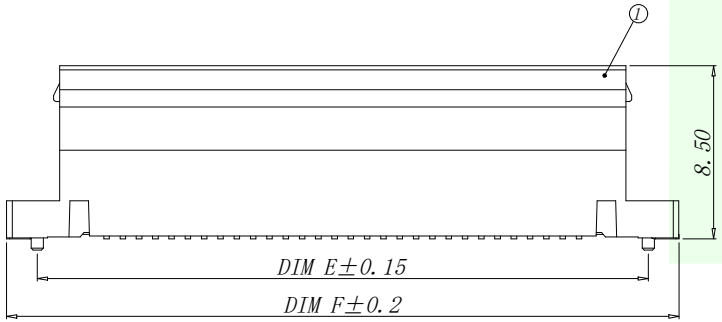


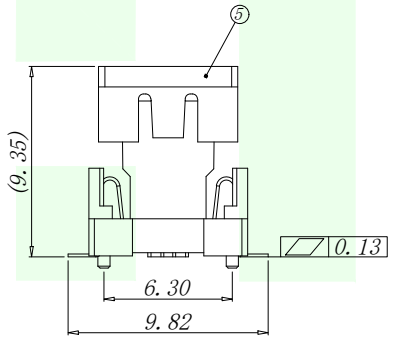
序号	品名	材质
①	0.8 Pitch D型浮动式立式BTB母座浮动胶芯	PA10T UL94 V-0,颜色:黑色
②	0.8 Pitch D型浮动式立式BTB母座底座	PA10T UL94 V-0,颜色:黑色
③	0.8 Pitch D型浮动式立式BTB母座端子	铜合金/表面点镀金
④	0.8 Pitch D型浮动式立式BTB母座焊片	铜合金/表面镀锡
⑤	0.8 Pitch D型浮动式立式BTB母座吸盖	LCP 130i UL94 V-0,颜色:黑色

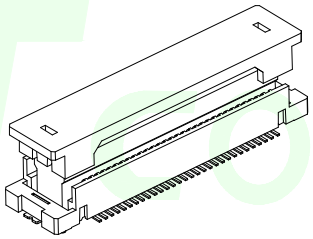
0.8 浮动式 SMT 板对板合高配合情况

合高 / 公座单高 / 母座单高	4.8	6.8
8.5	9.75	11.75

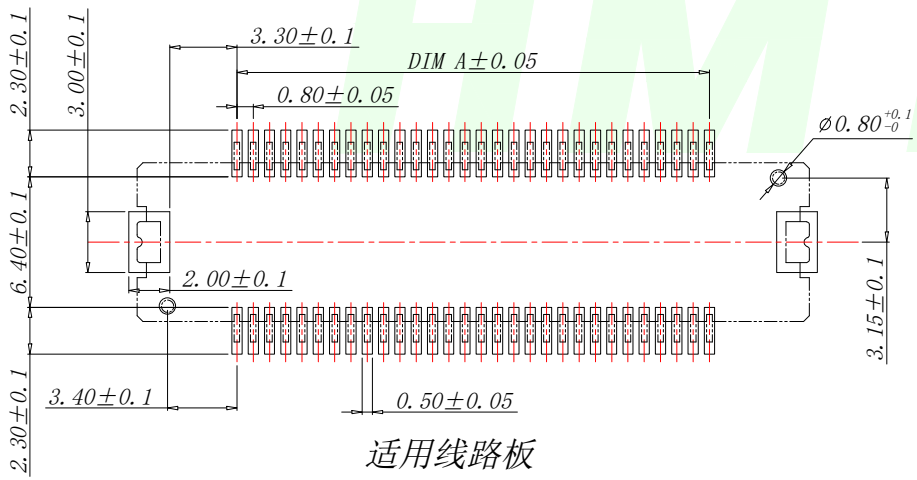
浮动式板对板支持X.Y.Z三方向±0.5的摆动







Part No	CKT	A	B	C	D	E	F
BTB0.8-MH8.5-30PDLT3	2X15	11.20	12.90	14.46	21.00	18.00	21.00
BTB0.8-MH8.5-40PDLT3	2X20	15.20	16.90	18.46	25.00	22.00	25.00
BTB0.8-MH8.5-50PDLT3	2X25	19.20	20.90	22.46	29.00	26.00	29.00
BTB0.8-MH8.5-60PDLT3	2X30	23.20	24.90	26.46	33.00	30.00	33.00
BTB0.8-MH8.5-70PDLT3	2X35	27.20	28.90	30.46	37.00	34.00	37.00
BTB0.8-MH8.5-80PDLT3	2X40	31.20	32.90	34.46	41.00	38.00	41.00
BTB0.8-MH8.5-90PDLT3	2X45	35.20	36.90	38.46	45.00	42.00	45.00
BTB0.8-MH8.5-100PDLT3	2X50	39.20	40.90	42.46	49.00	46.00	49.00
BTB0.8-MH8.5-110PDLT3	2X55	43.20	44.90	46.46	53.00	50.00	53.00
BTB0.8-MH8.5-120PDLT3	2X60	47.20	48.90	50.46	57.00	54.00	57.00



适用线路板

GENERAL TOLERANCES UNLESS SPECIFIED	
X.±0.50	±1°
.X±0.20	
.XX±0.10	
MANUFACTURE DWG	

HMT CONN 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd

PART NO.	BTB0.8-MH8.5-NPDLT3
TITLE:	0.8 Pitch D型浮动式立式BTB母座业务图(单高8.5)
DESIGN:	James
CHED:	Talen
APPD:	Sophia
CUSTOMER	
SIZE	A4
UNITS	MM
SCALE	N:A
SHEET	1/1